

P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^d	Q _g (Typ.)			
- 30	0.008 at V _{GS} = - 10 V	- 75	56 nC			
	0.011 at V _{GS} = -4.5 V	- 65	30110			

FEATURES

- Halogen-free
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

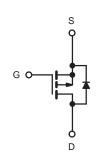


RoHS

APPLICATIONS

- Load Switch
- · Notebook Adaptor Switch





P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V	
Gate-Source Voltage	V_{GS}	± 20	V	
	T _C = 25 °C		- 75	
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C		- 65	
Continuous Diam Current (1 j = 130 °C)	T _A = 25 °C	l _D	-55 ^{a, b}	
	T _A = 70 °C		-45 ^{a, b}	Α
Pulsed Drain Current	I _{DM}	- 200	A	
Continuous Course Davis Diada Current	T _C = 25 °C		- 4.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	ls =	- 2.2 ^{a, b}	
Avalanche Current		I _{AS}	- 75	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	280	mJ
	T _C = 25 °C		250	
Maximum Power Dissipation	T _C = 70 °C		205	14/
	T _A = 25 °C	P _D	3.7 ^{a, b}	W
	T _A = 70 °C		2.7 ^{a, b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	38	46	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	20	25		

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on T_C = 25 °C.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 34		mV/
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η η = - 230 μΑ		5.3		°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 1.0		- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 100	nA
Zana Cata Valta na Duain Course	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V		- 1		
Zero Gate Voltage Drain Current		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α
	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 10 A		0.008		
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 8 A		0.011		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 10 A		28		S
Dynamic ^b						
Input Capacitance	C _{iss}	C _{iss}		4550		
Output Capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1455		pF
Reverse Transfer Capacitance	C _{rss}			570		
	Q _g	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 10 A		115		nC
Total Gate Charge				56		
Gate-Source Charge		V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 10 A		8		
Gate-Drain Charge	Q _{qd}			22		
Gate Resistance	R _g	f = 1 MHz	0.5	2.2	4.4	Ω
Turn-On Delay Time	t _{d(on)}			13	25	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$		12	24	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		40	70	
Fall Time	t _f			9	18	1
Turn-On Delay Time	t _{d(on)}			48	80	ns
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$		92	160	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		34	60	
Fall Time	t _f	1		19	35	
Drain-Source Body Diode Characteris	tics	,				
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.1	А
Pulse Diode Forward Current	I _{SM}	_			- 60	
Body Diode Voltage	V _{SD}	I _S = - 3 A, V _{GS} = 0 V		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time t _{rr}		- 55		27	45	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1		16	27	nC
Reverse Recovery Fall Time	t _a	$I_F = -10 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 \text{ °C}$		12		ns
Reverse Recovery Rise Time	t _b	1		15		

Notes:

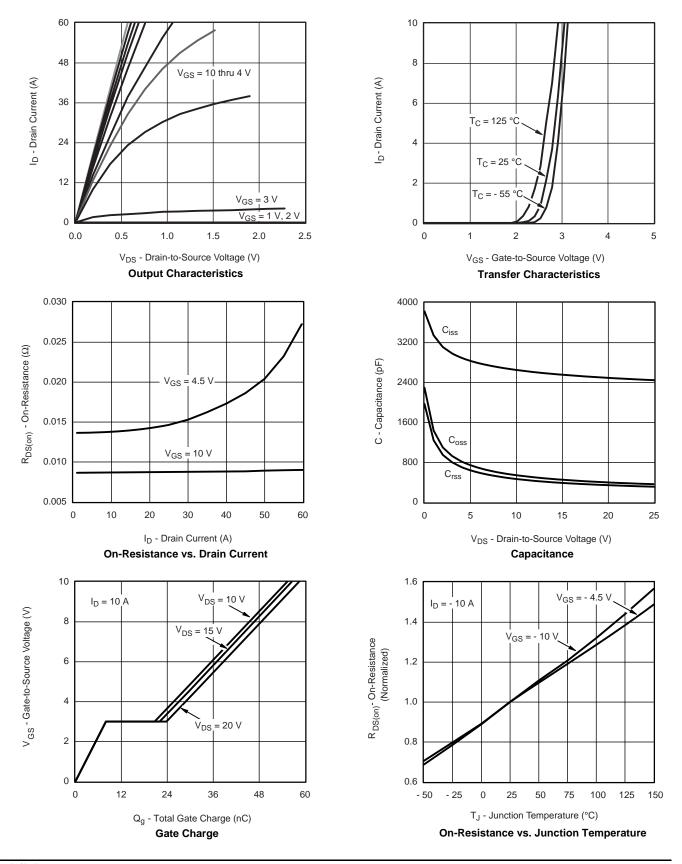
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

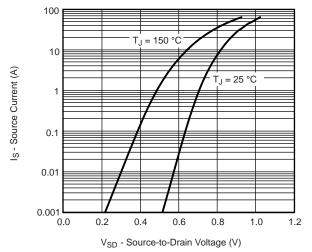


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

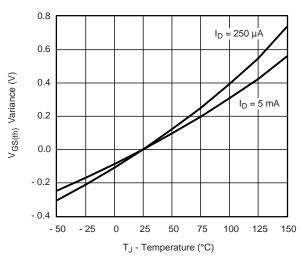




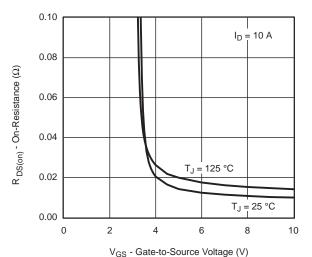
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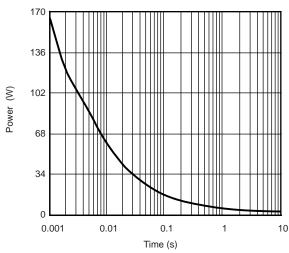
Source-Drain Diode Forward Voltage



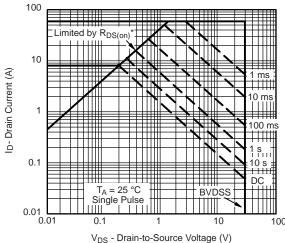
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

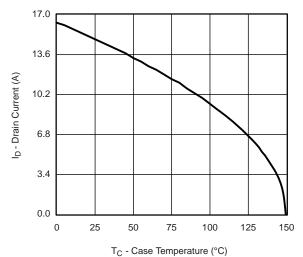


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

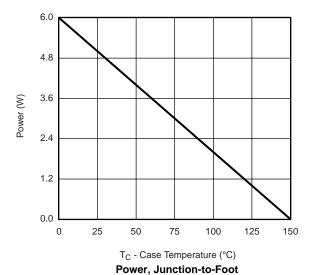
Safe Operating Area

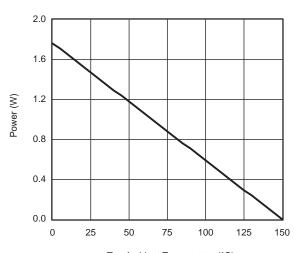


MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*



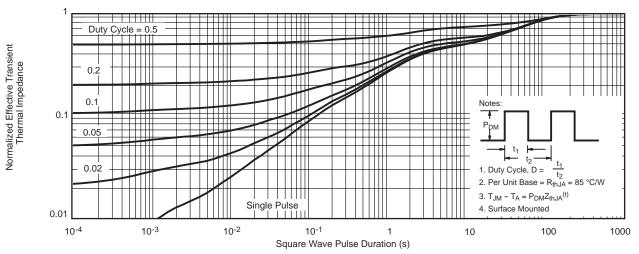


T_A - Ambient Temperature (°C) Power Derating, Junction-to-Ambient

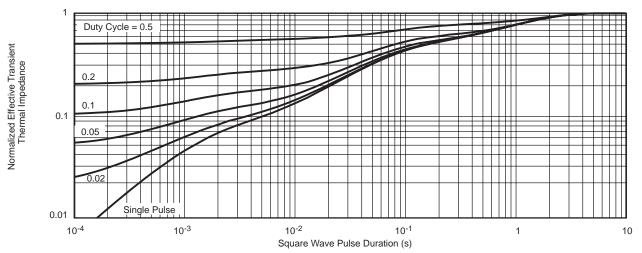
^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



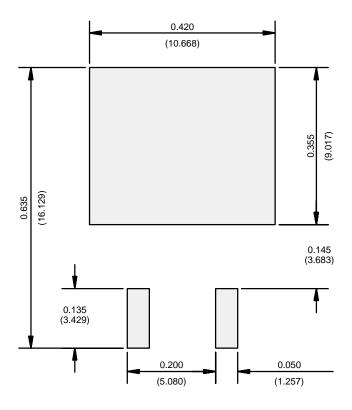
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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